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				Application Number	***
				Filing Date	December 10, 2003
				First Named Inventor:	Je-Young Chang
				Group Art Unit	***
				Examiner Name	***
Sheet	1	of	1	Attorney Docket Number	42P18071

U.S. PATENT DOCUMENTS						
Exam. Initial*	Cite No. <sup>1</sup>	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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OTHER ART - NON PATENT LITERATURE DOCUMENTS			
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JHw		CHIEN, Liang-Han et al., "Experimental Study of Evaporation Resistance on Porous Surfaces in Flat Heat Pipes", IEEE Proceedings of the 8th Intersociety Conference on Thermal and Thermomechanical Phenomena in Electronic Systems (ITherm 2002), pp. 236-242, San Diego, CA, May 29 - June 1, 2002.	

Examiner Signature	Gregory A. Wilson	Date Considered	7/28/04
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup>Unique citation designation number. <sup>2</sup>See attached Kinds of U.S. Patent Documents. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard S.3). <sup>4</sup>For Japanese patent documents, the indication of the year of reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.